

L Number	Hits	Search Text	DB	Time stamp
1	310857	polypropylene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:02
2	1640	"hydrogenated styrene butadiene"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:02
3	76799	"block copolymer"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:02
4	714	polypropylene and "hydrogenated styrene butadiene" and "block copolymer"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:19
5	2	"tuftec H1031"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:23
6	264	"1 2 bonds"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:24
7	2	(polypropylene and "hydrogenated styrene butadiene" and "block copolymer") and "1 2 bonds"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:36
8	202	"1 2 binding"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:36
9	1	polypropylene and "hydrogenated styrene butadiene" and "1 2 binding"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:43
10	6141	sebs	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:44
11	2348	sebs and polypropylene	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:44
13	1370	"slush molding"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:44
14	21	(sebs and polypropylene) and "slush molding"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 19:50
15	66	"0015681"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 20:43

16	10850	yonezawa	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 20:43
17	1293	sekikawa	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 20:43
18	5	yonezawa and sekikawa	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 20:43

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1	189	polypropylene and "hydrogenated block copolymer" and "styrene content"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/23 11:34